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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10073240	FILING DATE 02/13/2002	CLASS 257	SUBCLASS	GAU 2811	EXAMINER KANG
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****CONTINUING DATA VERIFIED:**

THIS APPLICATION IS A DIV OF 09/381,396 09/20/1999
WHICH IS A 371 OF PCT/JP98/01271 03/24/1998

**** FOREIGN APPLICATIONS VERIFIED:**

JAPAN 9-074994 03/27/1997
JAPAN 9-074993 03/27/1997

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PG-PUB ☐ DO NOT PUBLISH ☐

RESCIND ☐

Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO

520.37607VX1

TITLE : Semiconductor device and fabrication method thereof

U.S. DEPT. OF COMM./PAT. & TM-PTO-438L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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